

1 DECLARATION OF JOINT INVENTORS FOR PATENT APPLICATION

2 As the below named inventor, I hereby declare that:

3 My residence, post office address and citizenship are as stated
4 below next to my name.

5 I believe I am the original, first and joint inventor of the subject
6 matter which is claimed and for which a patent is sought on the invention
7 entitled: Capacitor Fabrication Methods and Capacitor Constructions, Serial
8 No. 09/653,156, filed August 31, 2000.

9 I hereby state that I have reviewed and understand the contents of
10 the above-identified specification, including the claims.

11 I acknowledge the duty to disclose information known to me to be
12 material to patentability as defined in Title 37, Code of Federal Regulations
13 §1.56.

14 **PRIOR FOREIGN APPLICATIONS:**

15 I hereby state that no applications for foreign patents or inventor's
16 certificates have been filed prior to the date of execution of this
17 declaration.

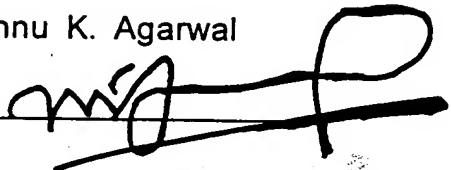
18 I hereby declare that all statements made herein of my own
19 knowledge are true and that all statements made on information and belief
20 are believed to be true; and further that these statements were made with
21 the knowledge that willful false statements and the like so made are
22 punishable by fine or imprisonment, or both, under Section 1001 of
Title 18 of the United States Code and that such willful false statement

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1 may jeopardize the validity of the application or any patent issued
2 therefrom.

3 * * * * *

4 Full name of inventor: Vishnu K. Agarwal

5 Inventor's Signature: 

6 Date: 11/28/00

7 Residence: Boise, Idaho

8 Citizenship: India

9 Post Office Address: 2463 E. Red Cedar Lane, #103
Boise, ID 83716

10 * * * * *

11 Full name of inventor: Garry A. Mercaldi

12 Inventor's Signature: 

13 Date: 11/28/00

14 Residence: Boise, Idaho

15 Citizenship: U.S.

16 Post Office Address: 2455 S. Pine Bar Place
17 Meridian, ID 83642